

# **HSB285S**

# Silicon Schottky Barrier Diode for High frequency detection

REJ03G0010-0100Z Rev.1.00 Apr,16.2003

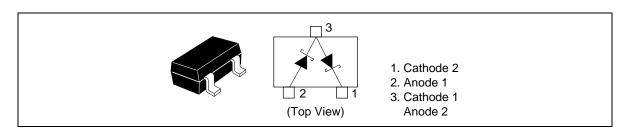
#### **Features**

- Low forward voltage, Low capacitance and High detection sensitivity.
- HSB285S which is interconnected in series configuration. is designed for voltage doubler use.
- CMPAK package is suitable for high density surface mounting and high speed assembly.

### **Ordering Information**

Type No.	Laser Mark	Package Code
HSB285S	S3	CMPAK

### **Pin Arrangement**



## **Absolute Maximum Ratings**

 $(Ta = 25^{\circ}C)$ 

Item	Symbol	Value	Unit
Reverse voltage	$V_R$	2	V
Average rectified current	I <sub>0</sub> *1	5	mA
Junction temperature	Tj	125	°C
Storage temperature	Tstg	-55 to +125	°C

Note: 1. Per one device

### **Electrical Characteristics** \*1

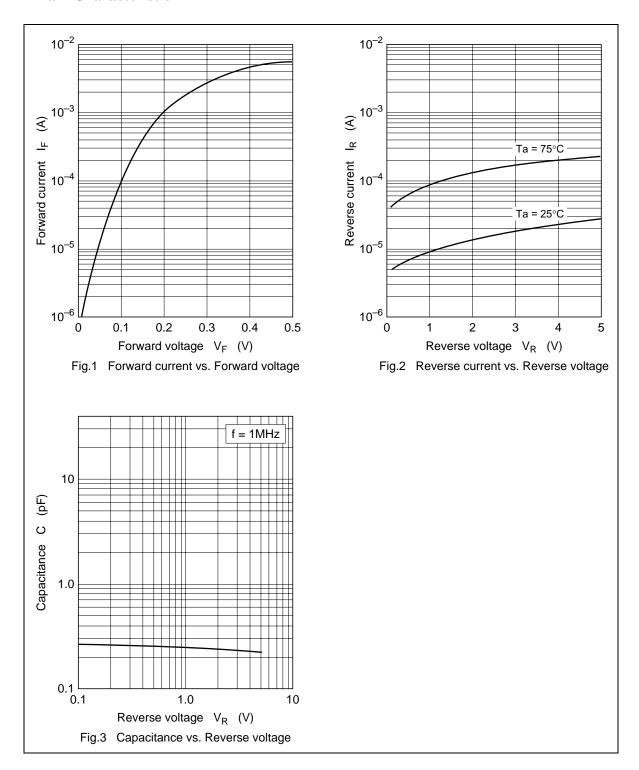
 $(Ta = 25^{\circ}C)$ 

Item	Symbol	Min	Тур	Max	Unit	Test Condition
Forward voltage	V <sub>F1</sub>	_	_	0.15	V	$I_{\rm F} = 0.1  \text{mA}$
	$V_{F2}$	_		0.27		I <sub>F</sub> = 1 mA
Capacitance	С	_	0.3	_	pF	$V_R = 1 \text{ V}, f = 1 \text{ MHz}$
ESD-Capability *2	_	10	_	_	V	$C = 200 \text{ pF}, R_L = 0 \Omega,$
						Both forward and reverse direction 1 pulse.

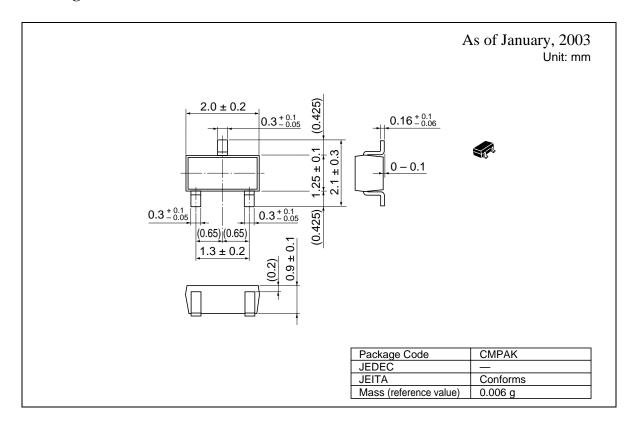
Notes: 1. Per one device

2. Failure criterion ;  $I_{\textrm{\tiny R}} \geq 100~\mu\textrm{A}$  at  $V_{\textrm{\tiny R}} = 0.5~\textrm{V}$ 

### **Main Characteristic**



### **Package Dimensions**



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